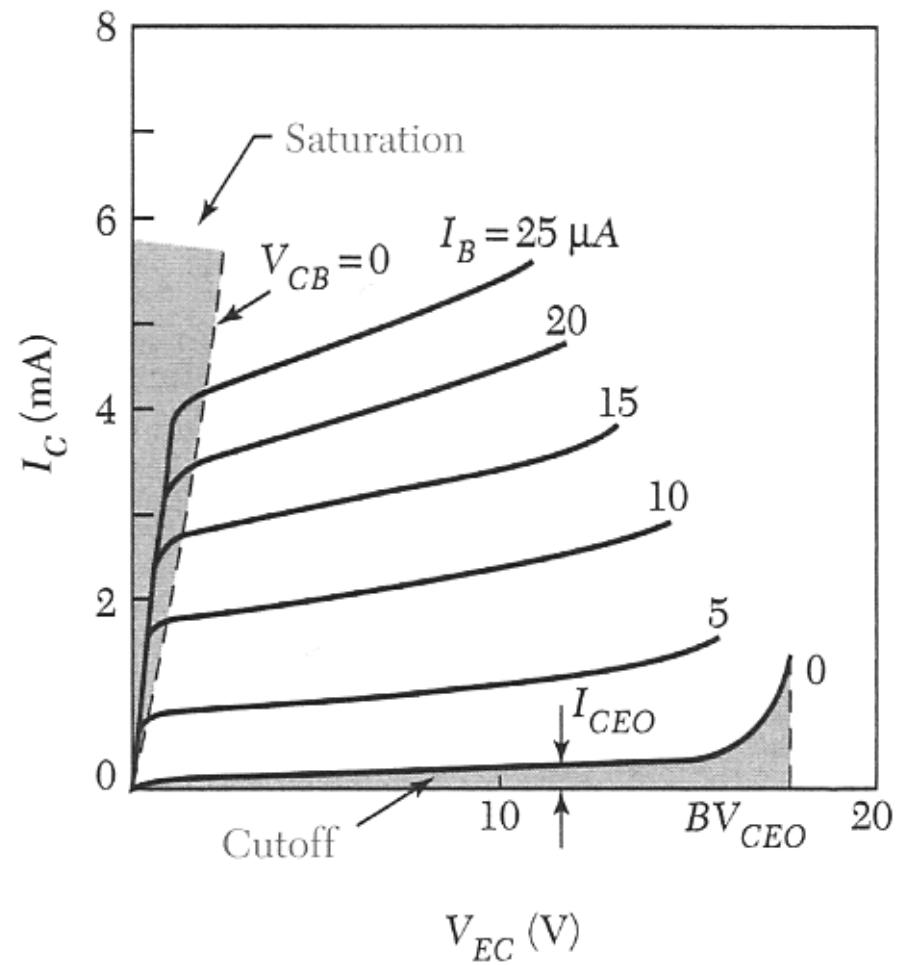
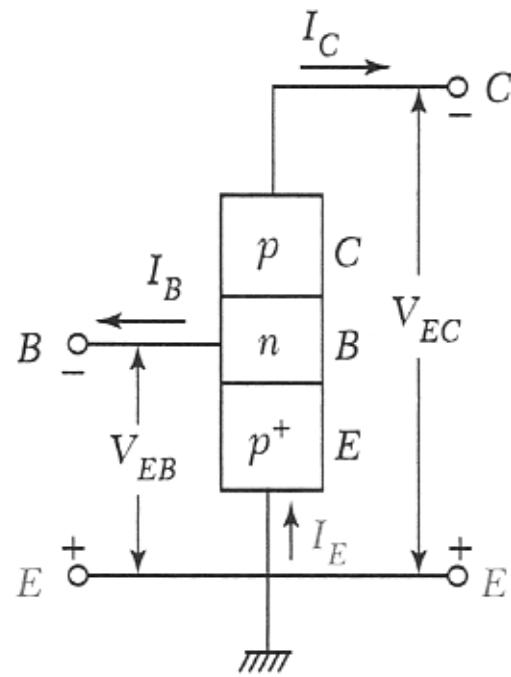


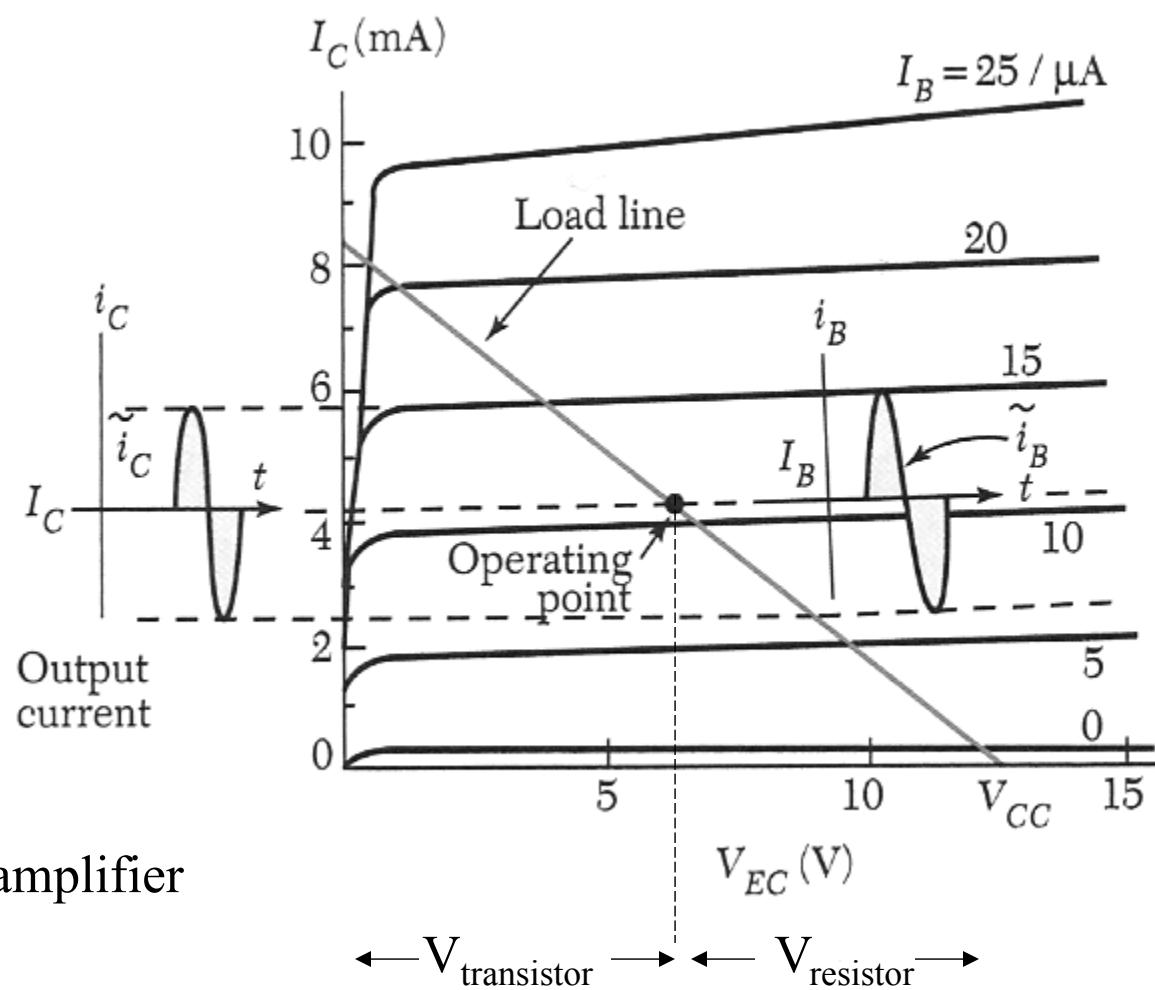
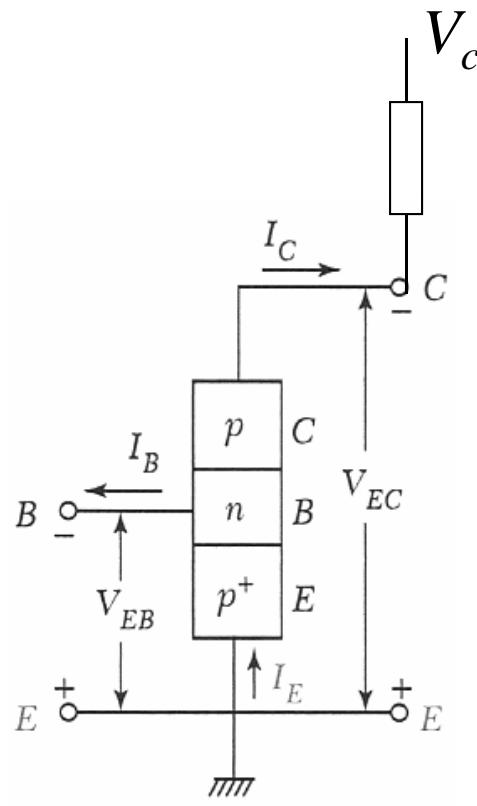
Bipolar Transistors

Common emitter configuration



$I_C \sim \beta I_B$ amplifier

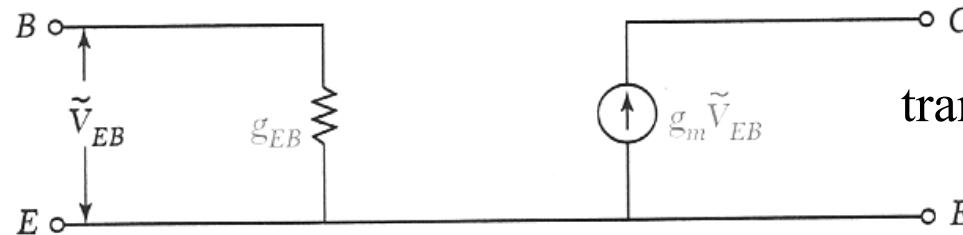
Small signal response



Low input impedance amplifier

Small signal response

$$\tilde{i}_c = \beta \tilde{i}_B = \beta g_{EB} \tilde{v}_{EB}$$

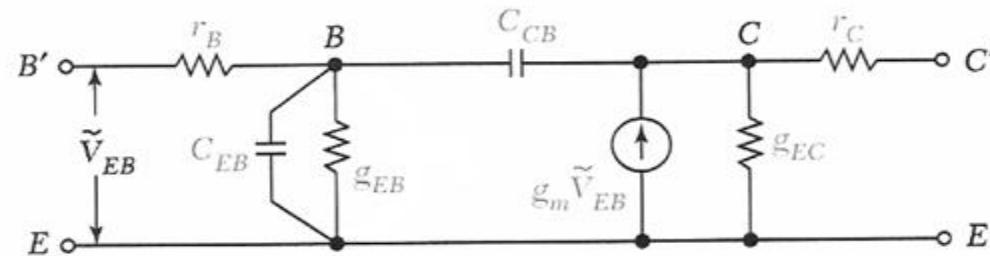
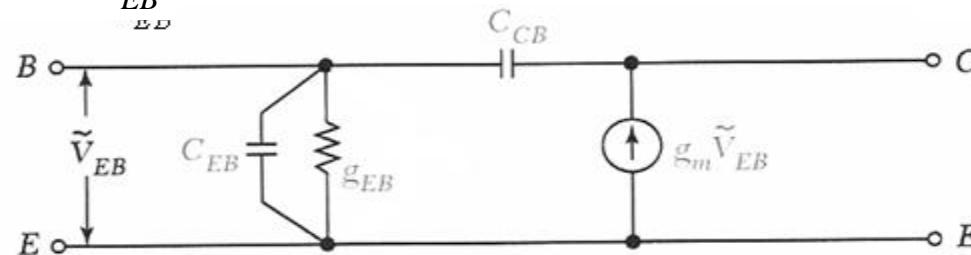


transistor man

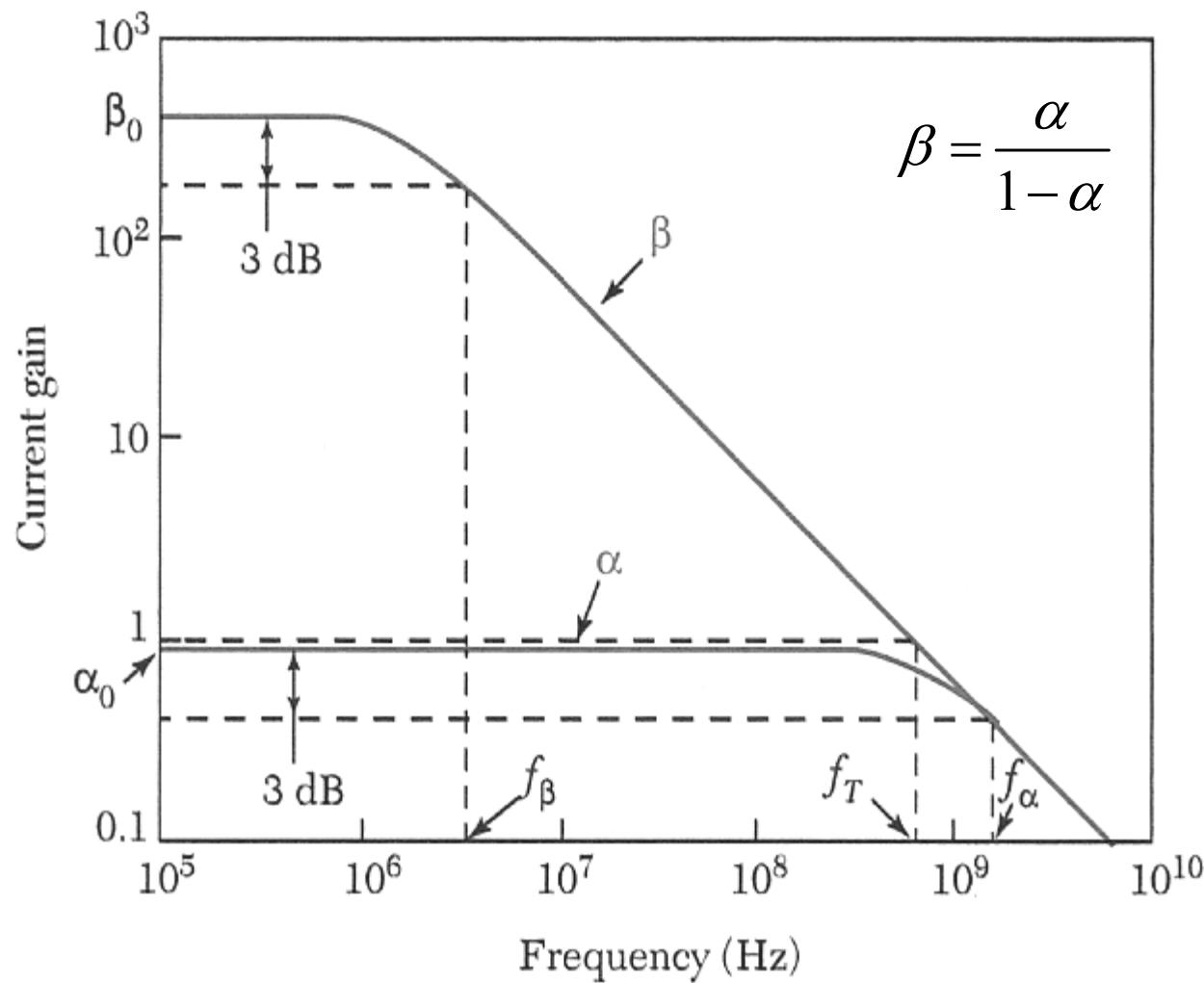
input conductance:

$$g_{EB} = \frac{\tilde{i}_B}{\tilde{v}_{EB}}$$

transconductance: $g_m = \frac{\tilde{i}_c}{\tilde{v}_{EB}}$



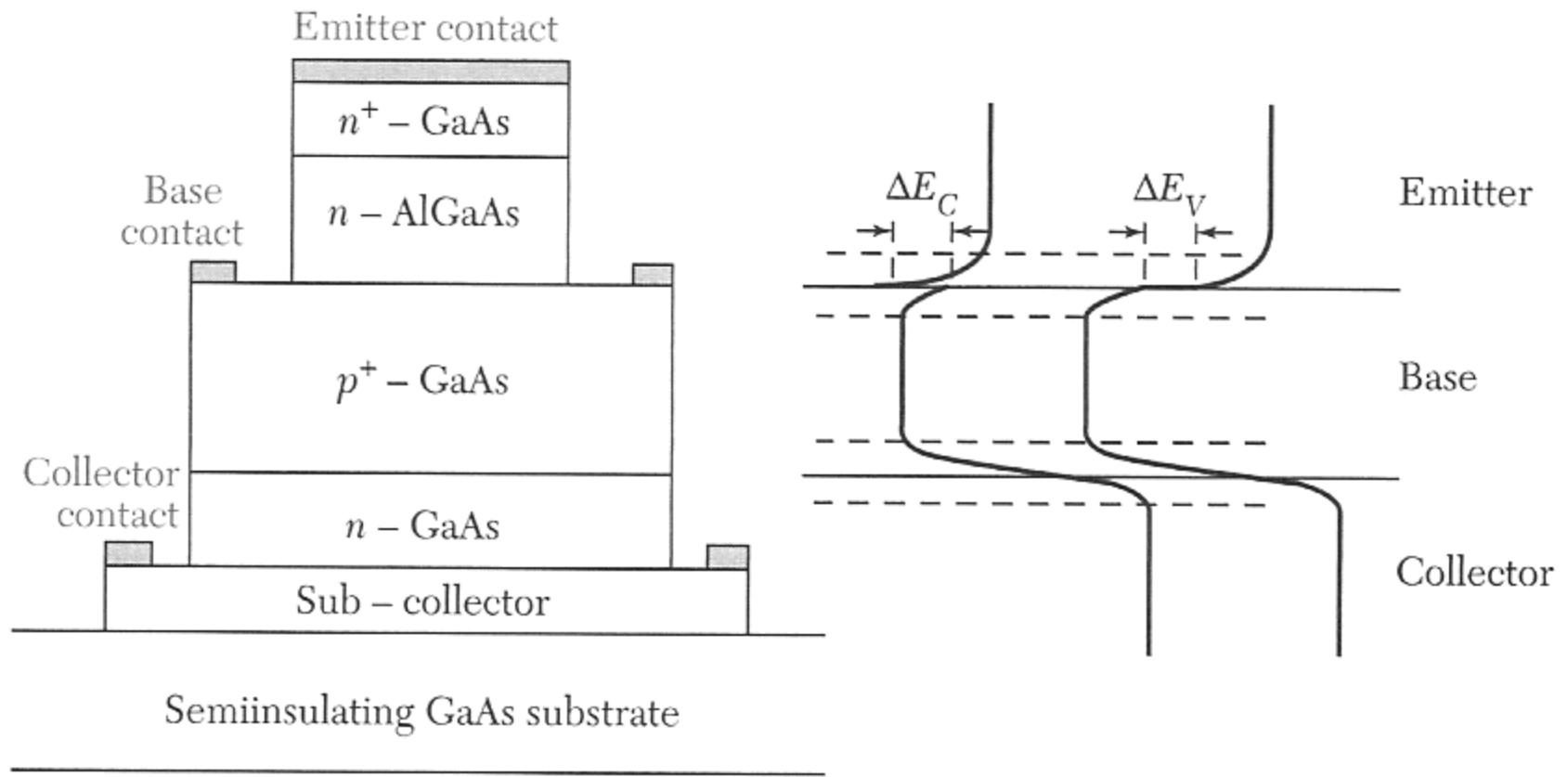
Small signal response



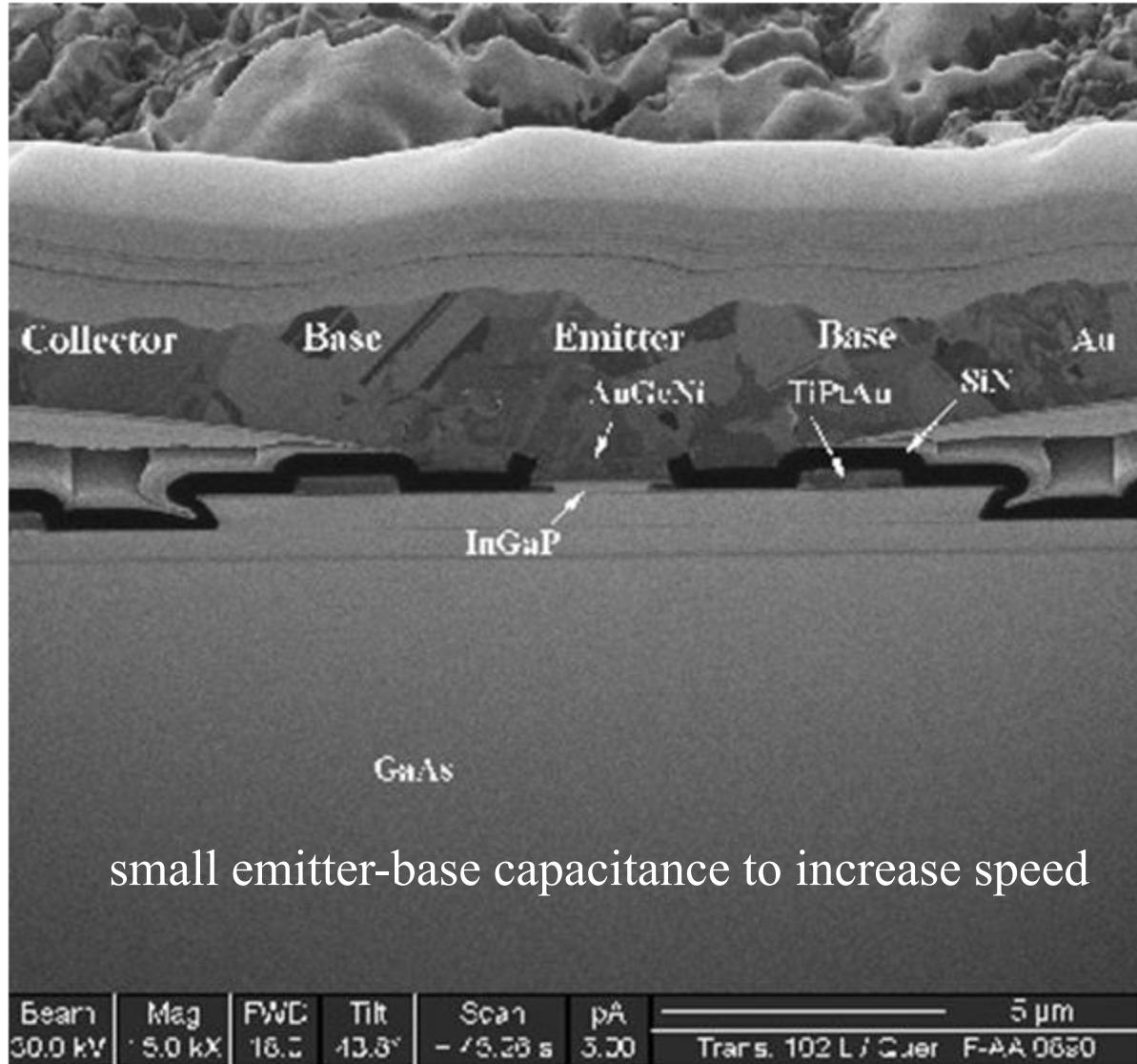
$$f_\beta = (1 - \alpha_0) f_\alpha$$

$$f_T = \alpha_0 f_\alpha$$

Heterojunction bipolar transistors



Heterojunction bipolar transistor



HBT current gain

$$I_C = \beta I_B$$

$$\beta = \frac{\alpha}{1-\alpha} \approx \frac{n_{B0}}{p_{E0}} \quad (\text{npn})$$

Higher doping in the emitter makes the minority carrier concentration lower in the emitter.

$$n_{B0} = \frac{n_i^2}{N_A} = \frac{N_C N_V \exp(-E_{gB} / k_B T)}{N_A}$$

$$p_{E0} = \frac{n_i^2}{N_D} = \frac{N'_C N'_V \exp(-E_{gE} / k_B T)}{N_D}$$

If the emitter and the base have different band gaps

$$\beta = \frac{N_E}{N_B} \frac{N_c N_v}{N'_c N'_v} \exp\left(\frac{\Delta E_g}{k_B T}\right) \sim 100000$$

HBT current gain

A HBT has an emitter bandgap of 1.62 and a base bandgap of 1.42.

A BJT has an emitter bandgap of 1.42 and a base bandgap of 1.42.

Both have an emitter doping of 10^{18} cm^{-3} and a base doping of 10^{15} cm^{-3} .

How much larger is the gain in the HBT?

$$\frac{\beta(\text{HBT})}{\beta(\text{BJT})} = \exp\left(\frac{\Delta E_g}{k_B T}\right) = \exp\left(\frac{1.62 - 1.42}{0.0259}\right) = 2257$$

HBT

Trade off gain for higher speed

Higher base doping

- lower base resistance

- reduced Early effect

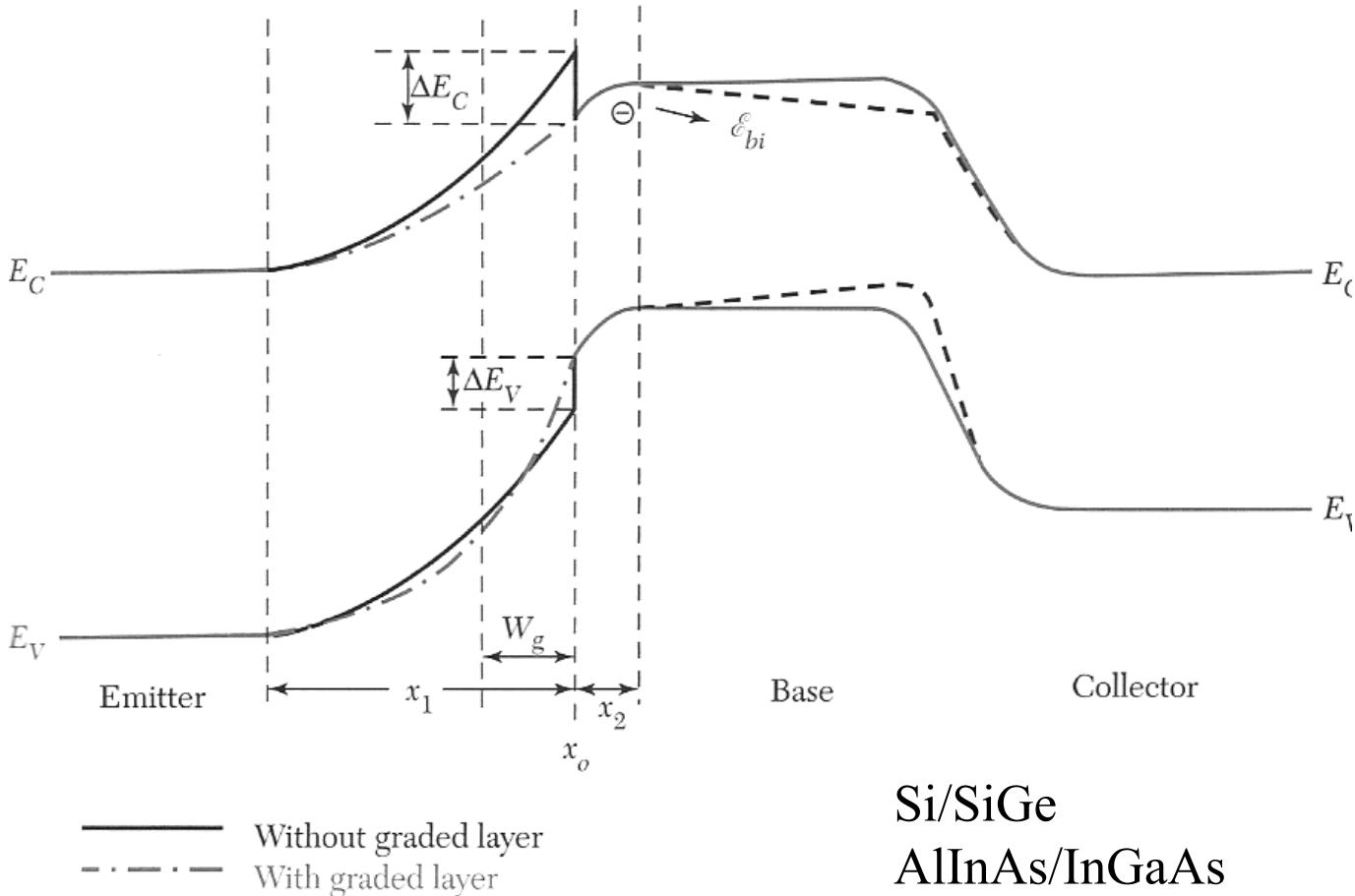
- less trouble with punch through

- base can be made thinner -> faster transistors

Because of higher base doping, a higher collector doping is possible without punch through

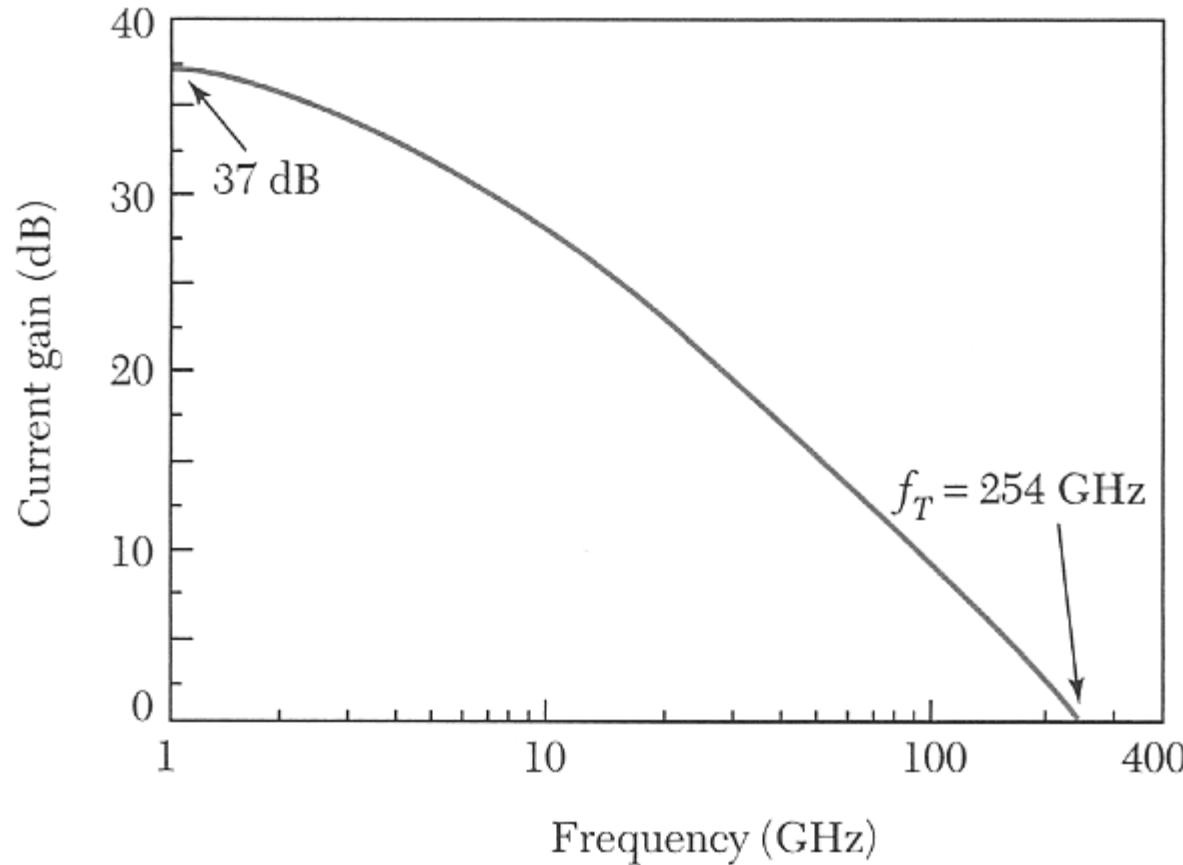
- lower collector resistance

HBT current gain



band discontinuity reduces emitter efficiency
Graded layer emitter and base improve performance

Heterojunction bipolar transistors



Fastest InP/InGaAs HBT's have an f_T of 710 GHz.

Higher doping in the base allows for a thinner base without punch through and lower base resistance and thus higher frequency operation

Microwave engineering

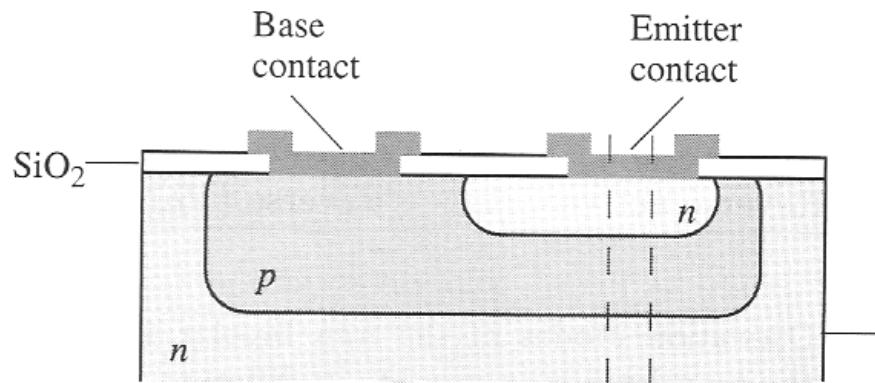
Electronics: $L \ll \lambda$ $f < \sim 10 \text{ GHz}$

Microwave: $\lambda < L$ $10 \text{ GHz} < f < 1 \text{ THz}$

TeraHertz: $\lambda \ll L$ $1 \text{ THz} < f < 100 \text{ THz}$

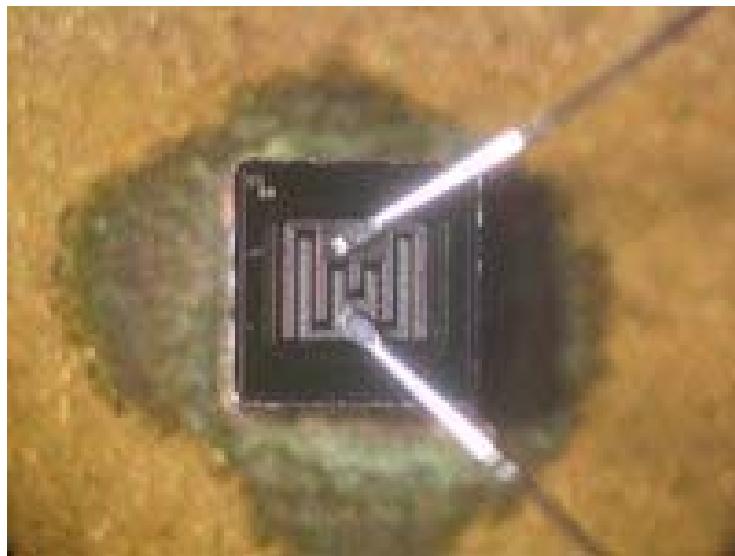
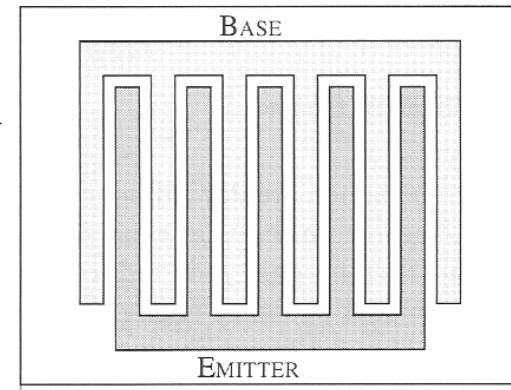
Optics: $\lambda \ll L$ 100 THz

Interdigitated contacts in power transistors

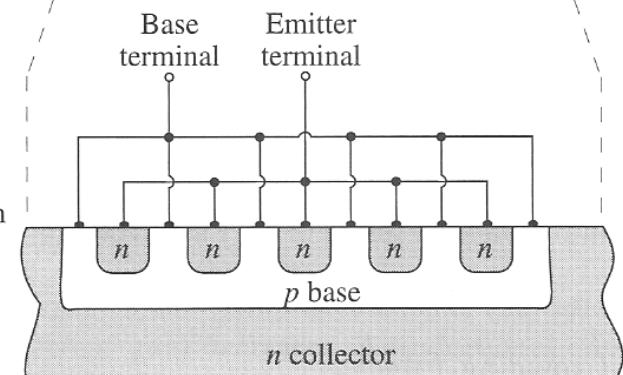


Interdigitated fingers to inject current uniformly into a bipolar device

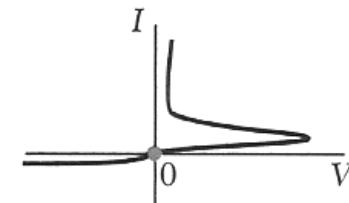
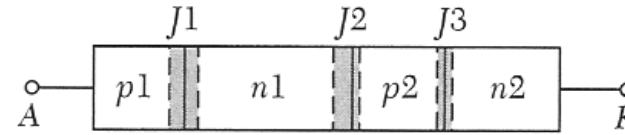
Top view



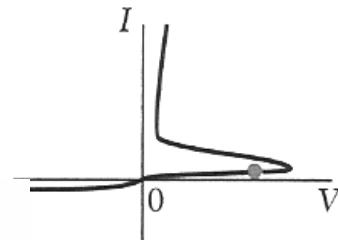
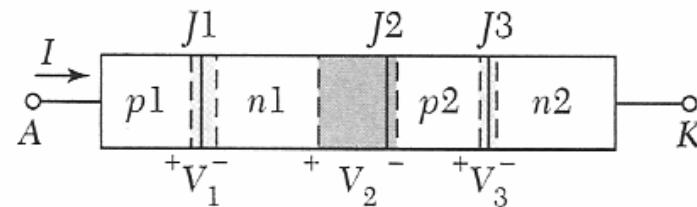
Cross-section



Thyristors

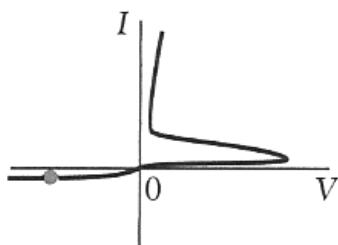
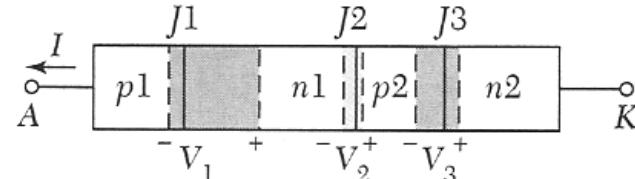


Forward blocking

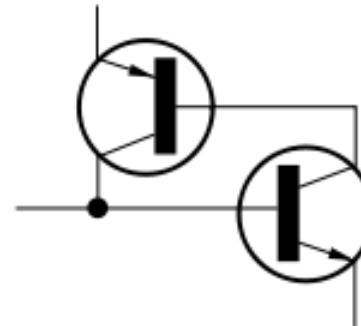
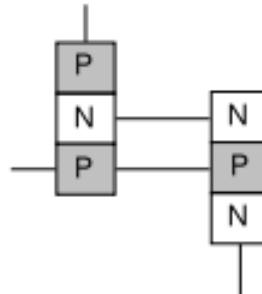
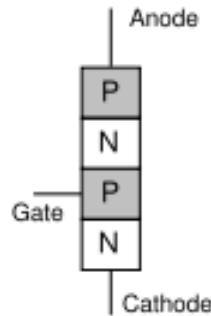


Forward conducting

Reverse blocking



Thyristors

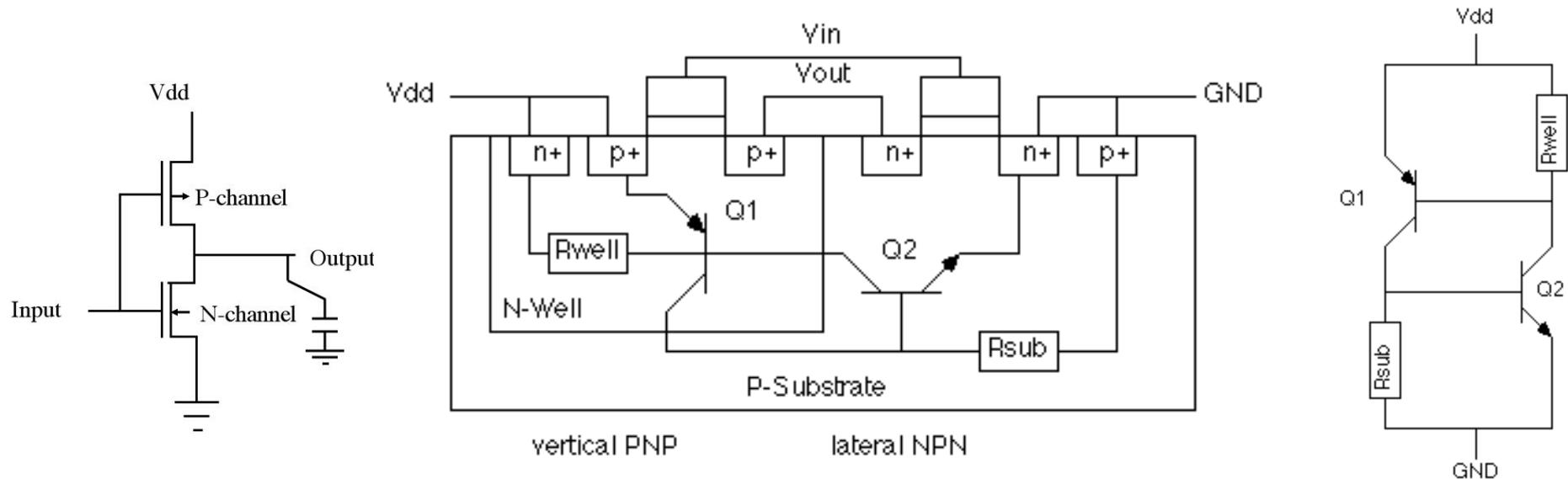


$$\beta_1 * \beta_2 > 1$$

Used for switching high currents or voltages

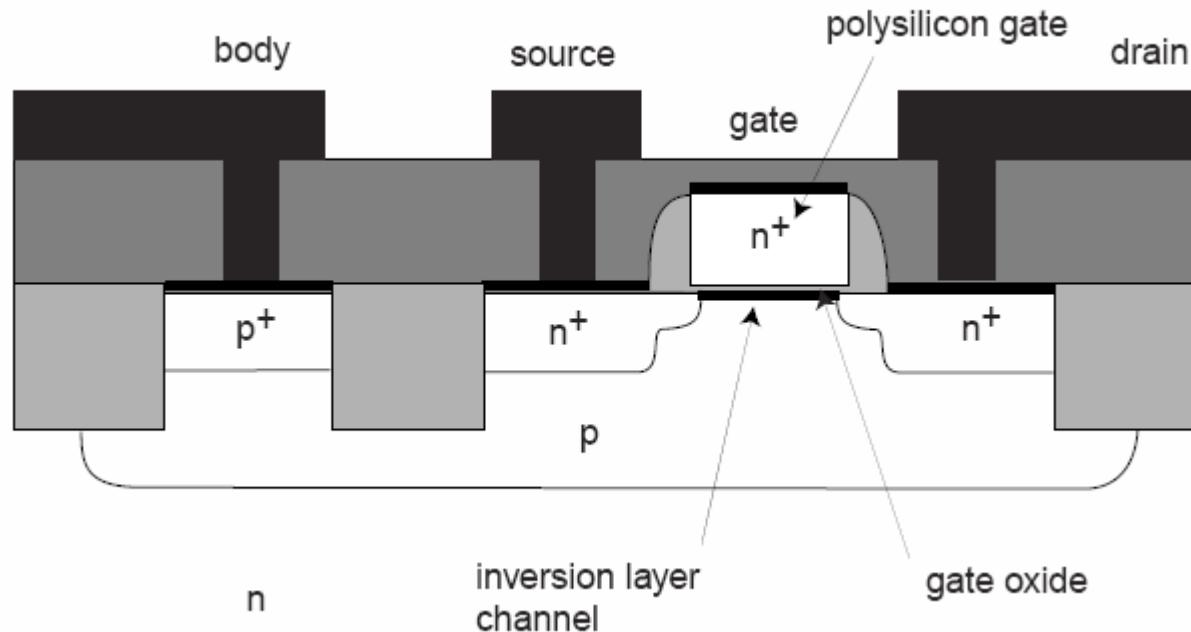


Latch-up



Both BJT's conduct, creating a low resistance path between V_{dd} and GND. The product of the gains of the two transistors in the feedback loop, is greater than one. The result of latchup is at the minimum a circuit malfunction, and in the worst case, the destruction of the device.

Subthreshold current



If the p-concentration in the channel is low, electrons emitted into the channel by the forward biased junction diffuse across the channel without recombining.

Optoelectronics

light emitting diode
laser diode
solar cell
waveguide
photo detectors



communications, memory (DVD), displays, printing, barcode readers, solar energy, lighting, laser surgery, measurement, guidance, spectroscopy, LiFi

Photo detectors

Intrinsic semiconductor $\sigma = e(\mu_n n + \mu_p p)$ (used in copiers)

Unbiased pn junction - like a solar cell

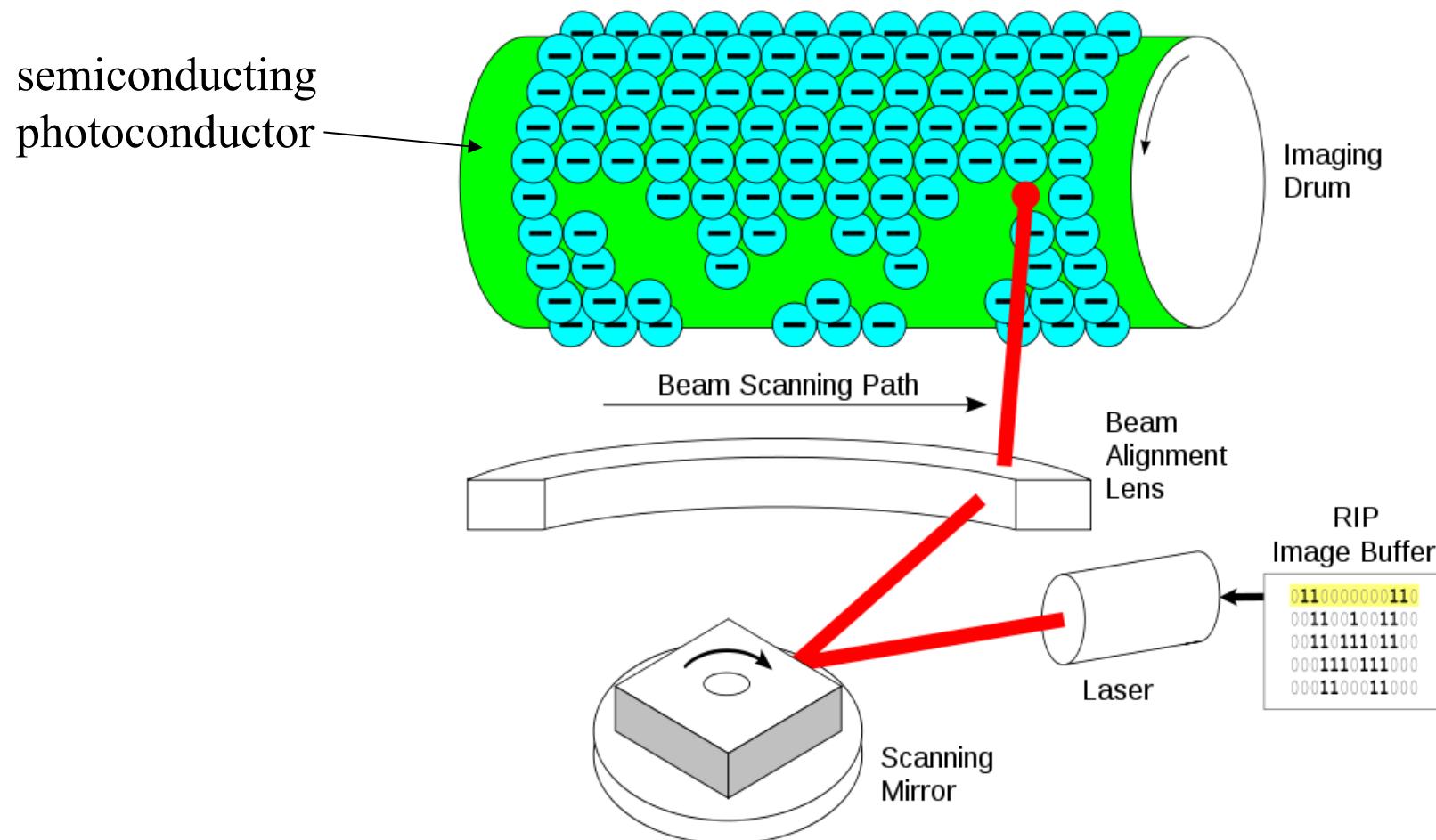
Reverse biased pn junction - smaller capacitance, higher speed, less noise

Phototransistor - light injects carriers into the base. This current is amplified. High responsivity.

Ambient light detectors.

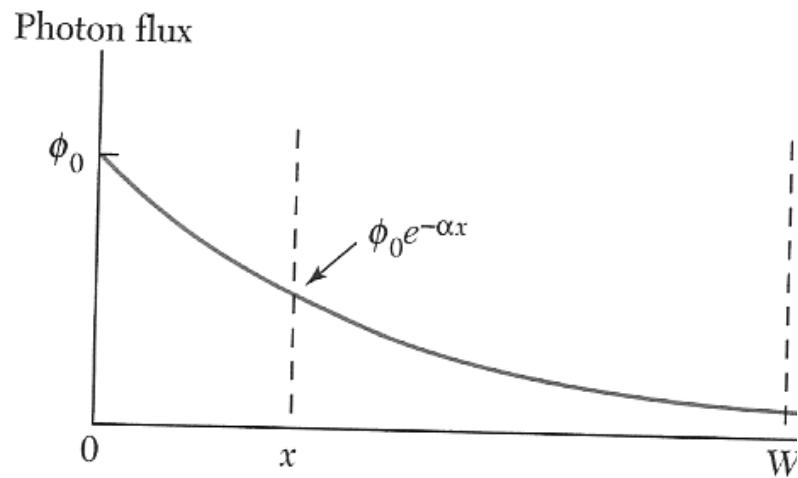
Active Pixel sensors for automated parking and gesture control (uses time-of-flight to image in 3-D).

Laser printer



Absorption

Photon flux: $\Phi(x) = \Phi_0 e^{-\alpha x}$

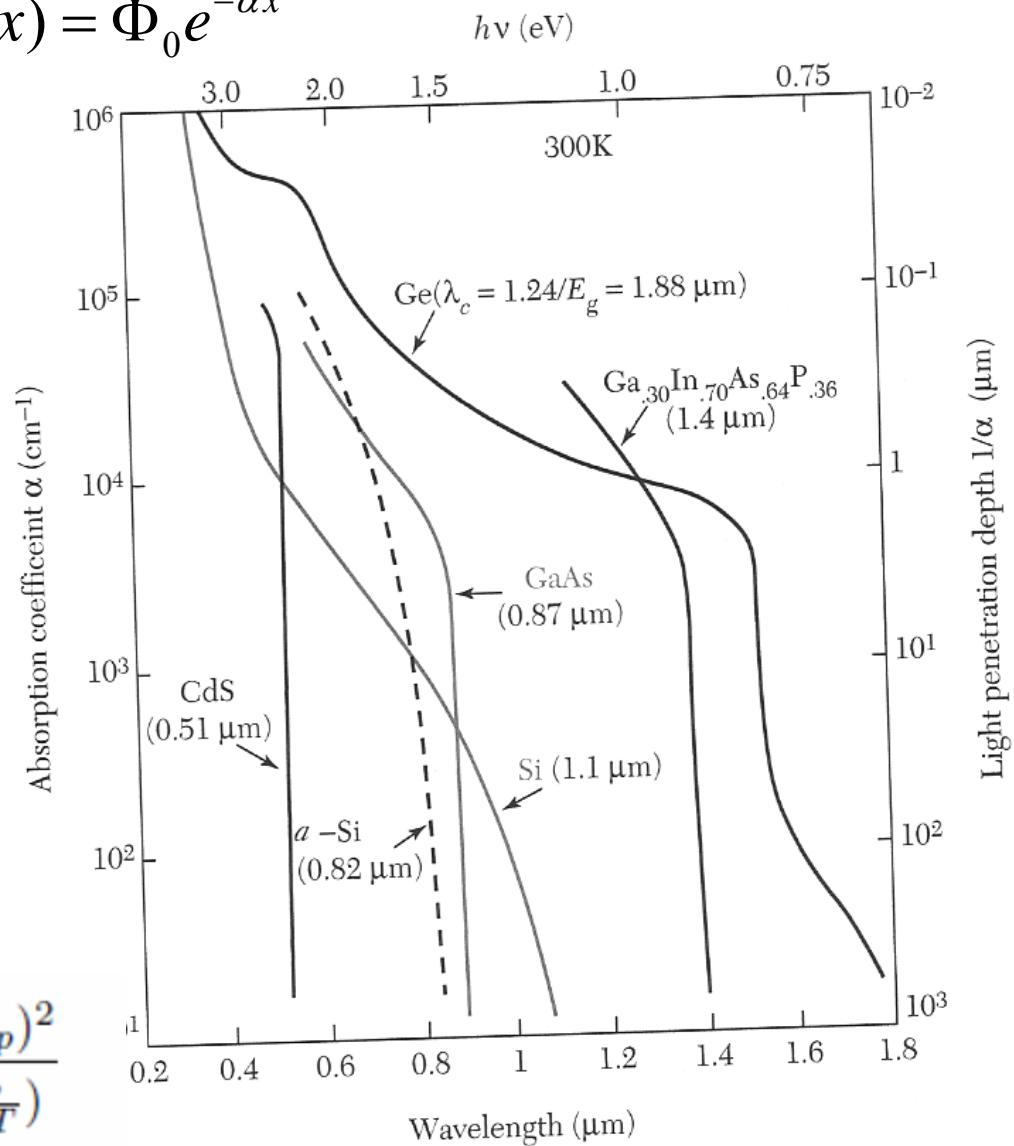


Sharp absorption edge for
direct bandgap materials

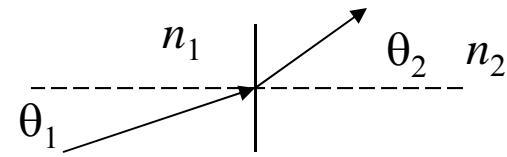
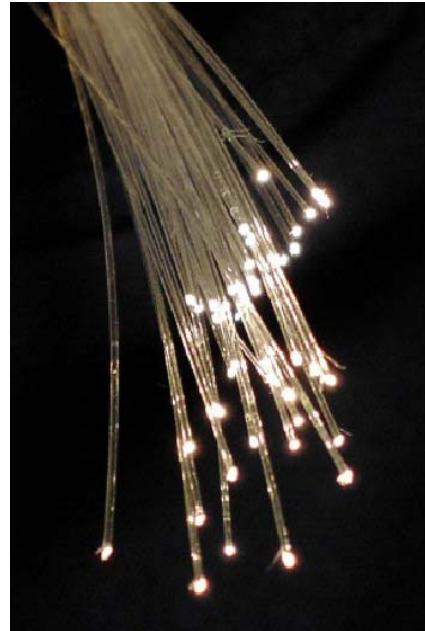
$$\alpha \approx 3.5 \times 10^6 \left(\frac{m_r^*}{m_0} \right)^{3/2} \frac{\sqrt{\hbar\omega - E_g}}{\hbar\omega} \text{ cm}^{-1}$$

direct bandgap indirect bandgap

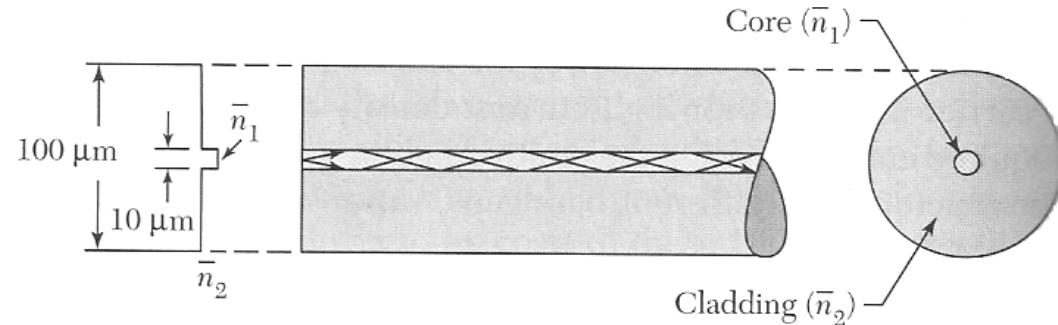
$$\alpha \propto \frac{(h\nu - E_g + E_p)^2}{\exp(\frac{E_p}{k_B T}) - 1} + \frac{(h\nu - E_g - E_p)^2}{1 - \exp(-\frac{E_p}{k_B T})}$$



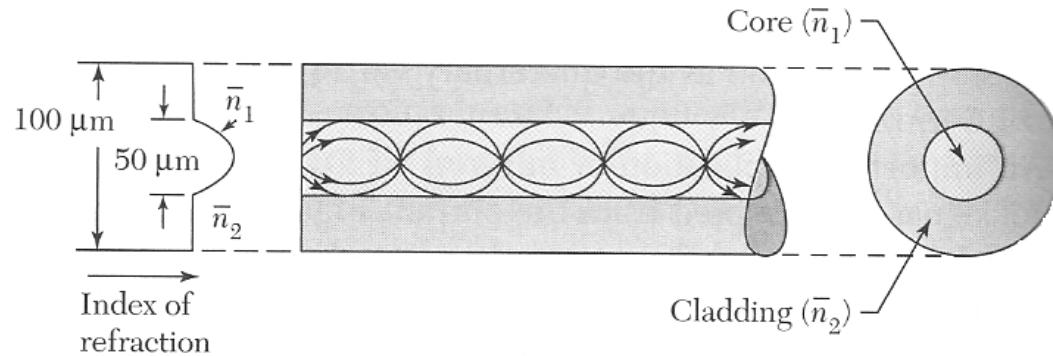
Confinement of light by total internal reflection



$$n_1 \sin \theta_1 = n_2 \sin \theta_2$$



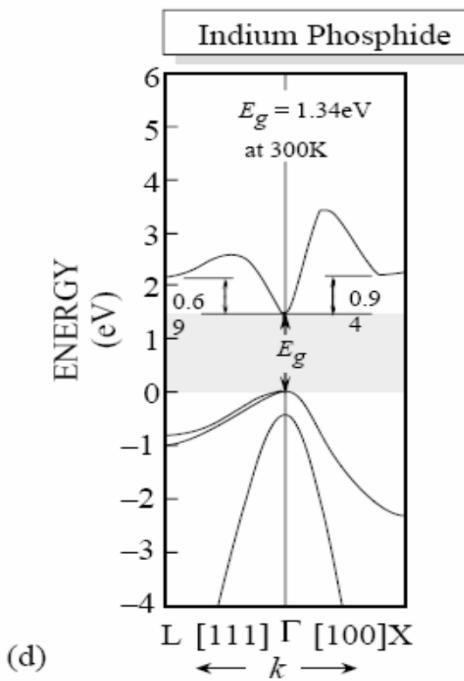
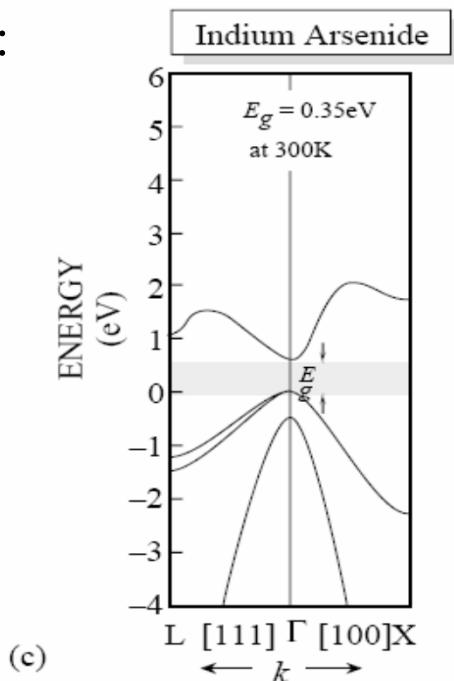
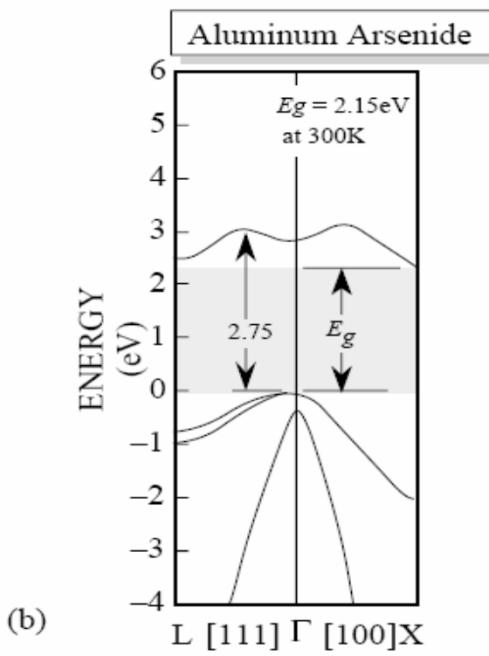
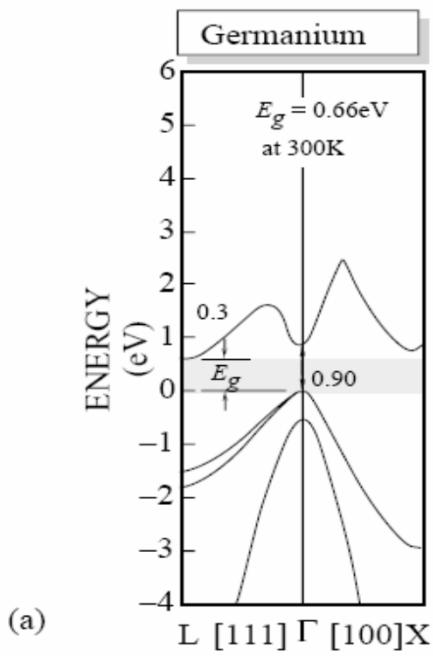
less pulse spreading for
parabolically graded fiber



0.6 dB/km at 1.3 μm and 0.2 dB/km at 1.55 μm

direct bandgap:
 $\Delta k = 0$

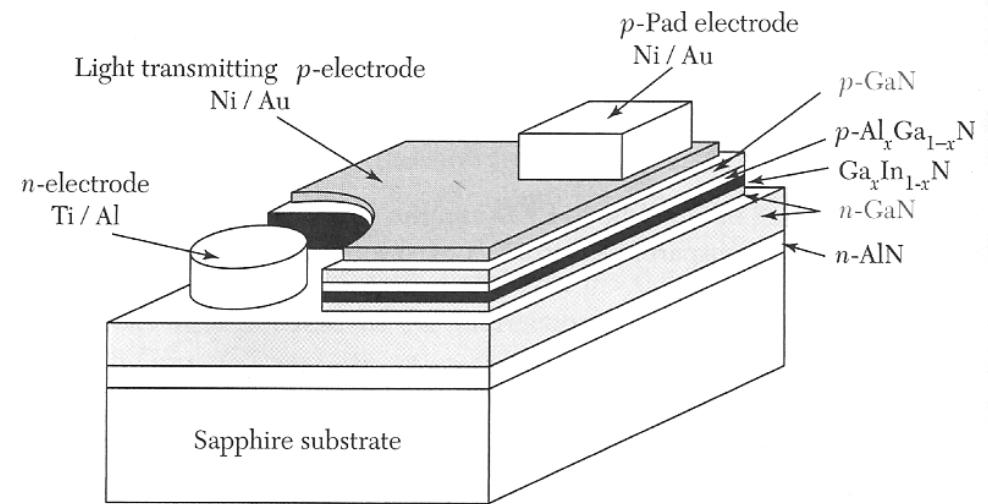
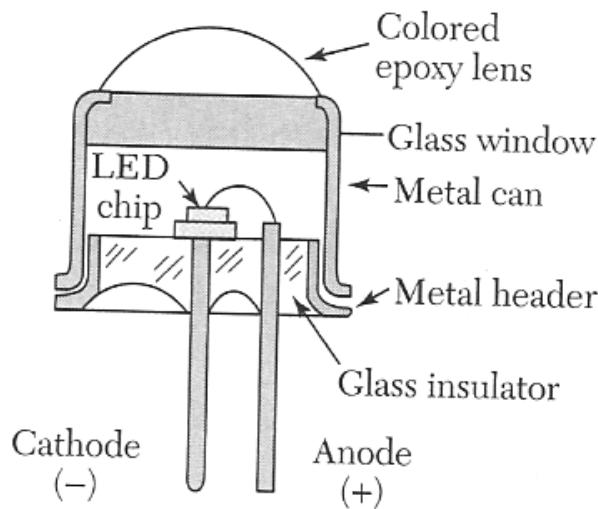
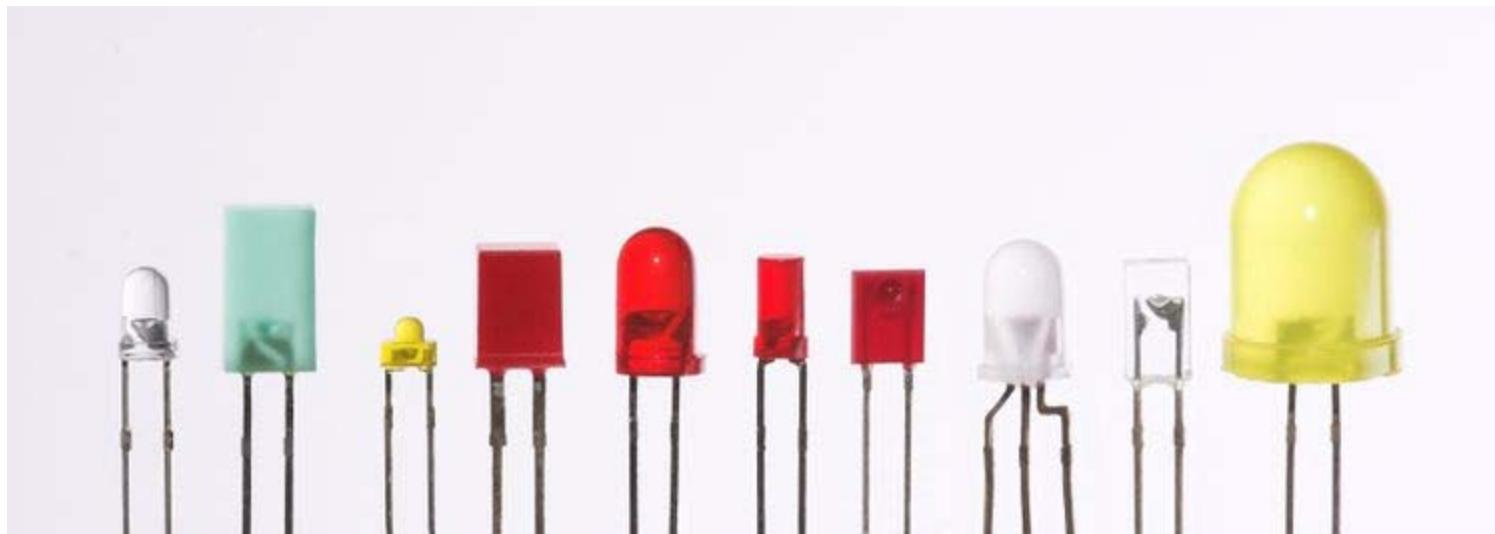
photons can be emitted



indirect bandgap:
 $\Delta k \neq 0$

phonons are emitted

Light emitting diodes

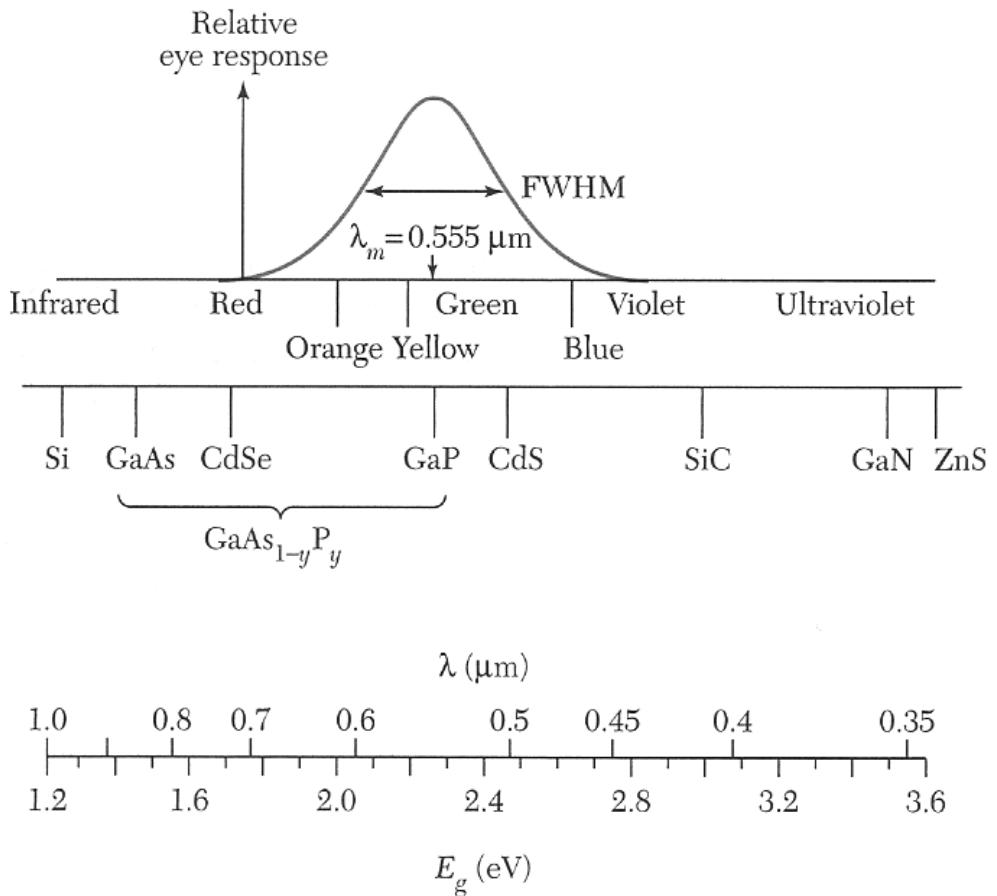


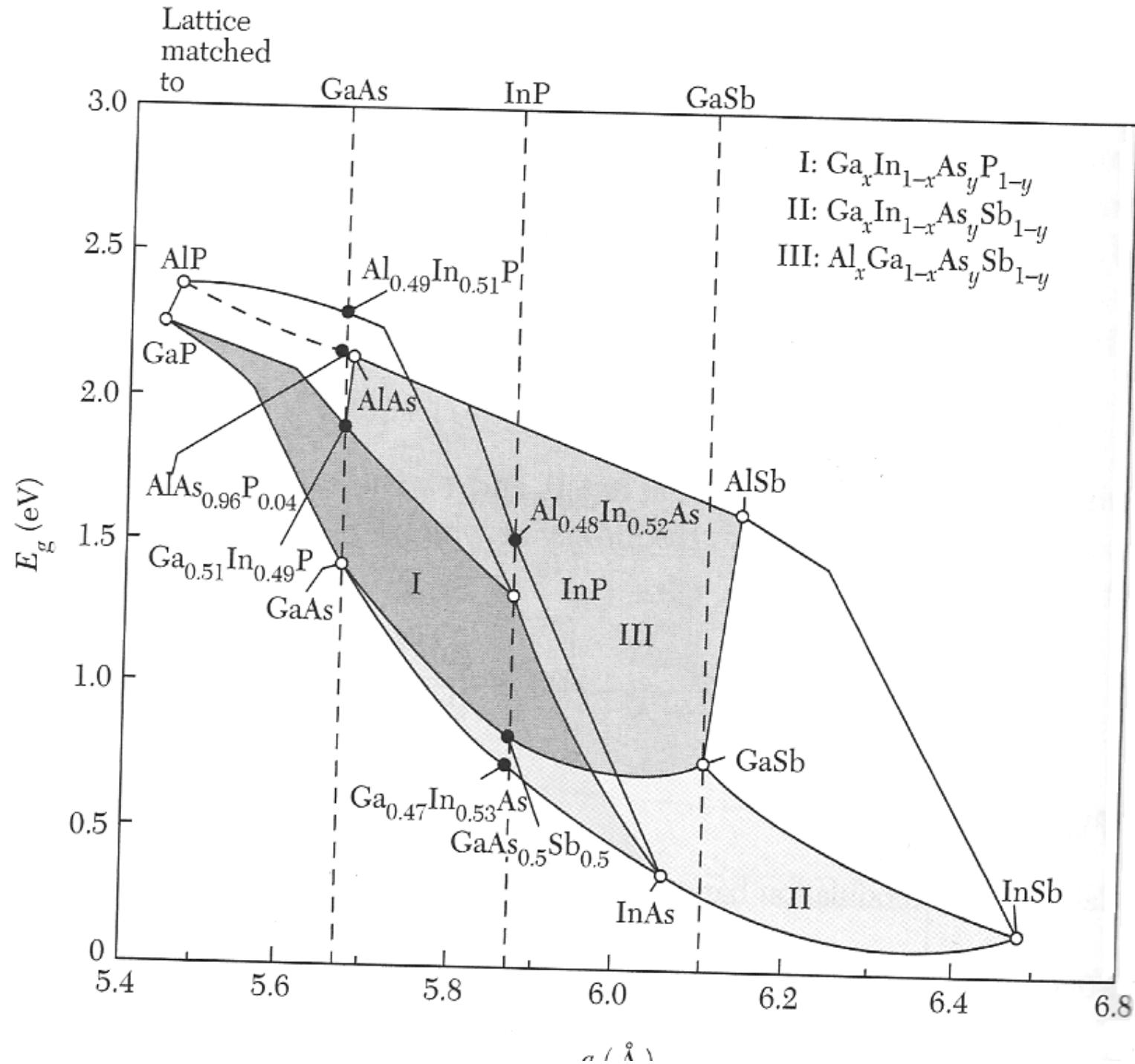
Solid state lighting is efficient.

TABLE 1 Common III-V materials used to produce LEDs and their emission wavelengths.

Material	Wavelength (nm)
InAsSbP/InAs	4200
InAs	3800
GaInAsP/GaSb	2000
GaSb	1800
$\text{Ga}_x\text{In}_{1-x}\text{As}_{1-y}\text{P}_y$	1100-1600
$\text{Ga}_{0.47}\text{In}_{0.53}\text{As}$	1550
$\text{Ga}_{0.27}\text{In}_{0.73}\text{As}_{0.63}\text{P}_{0.37}$	1300
GaAs:Er, InP:Er	1540
Si:C	1300
GaAs:Yb, InP:Yb	1000
$\text{Al}_x\text{Ga}_{1-x}\text{As:Si}$	650-940
GaAs:Si	940
$\text{Al}_{0.11}\text{Ga}_{0.89}\text{As:Si}$	830
$\text{Al}_{0.4}\text{Ga}_{0.6}\text{As:Si}$	650
$\text{GaAs}_{0.6}\text{P}_{0.4}$	660
$\text{GaAs}_{0.4}\text{P}_{0.6}$	620
$\text{GaAs}_{0.15}\text{P}_{0.85}$	590
$(\text{Al}_x\text{Ga}_{1-x})_{0.5}\text{In}_{0.5}\text{P}$	655
GaP	690
GaP:N	550-570
$\text{Ga}_x\text{In}_{1-x}\text{N}$	340, 430, 590
SiC	400-460
BN	260, 310, 490

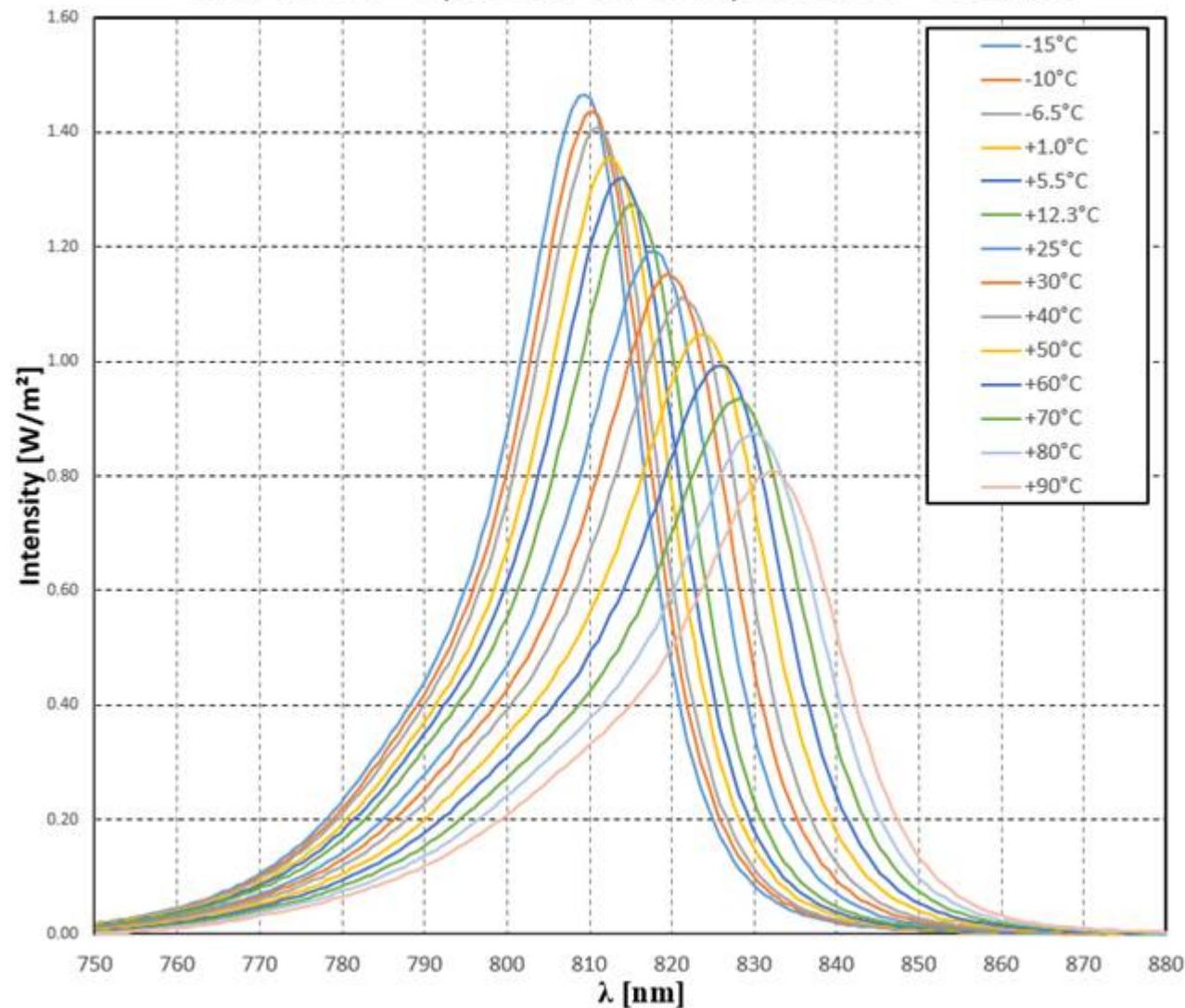
Light emitting diodes





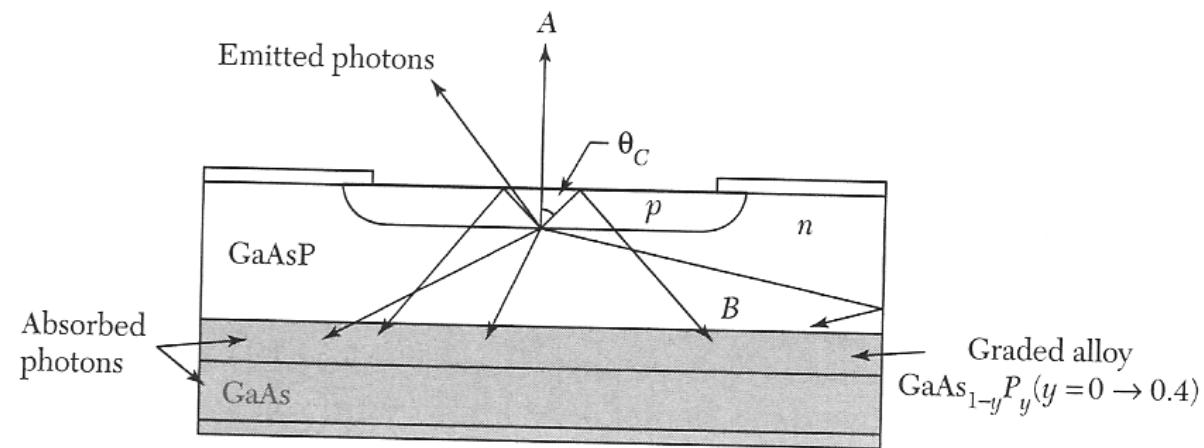
IR LED

SFH4780S - Spectral vs. Temperature - 100mA



Measurement by Jan Enenkel

Light emitting diodes



absorption
reflection
total internal reflection

